

DESCRIPTION

The SPP3401W is the P-Channel logic enhancement mode power field effect transistors are produced using high cell density, DMOS trench technology.

This high density process is especially tailored to minimize on-state resistance.

These devices are particularly suited for low voltage application such as cellular phone and notebook computer power management and other battery powered circuits, and low in-line power loss are needed in a very small outline surface mount package.

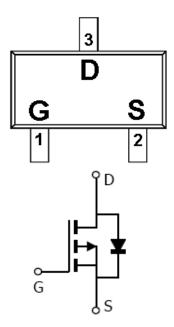
FEATURES

- -30V/-4.0A, RDS(ON)= $70m\Omega$ @VGS=- 10V
- -30V/-3.2A, RDS(ON)= $90m\Omega$ @VGS=-4.5V
- -30V/-1.2A, RDS(ON)= $115m\Omega$ @VGS=-2.5V
- ◆ Super high density cell design for extremely low RDS (ON)
- Exceptional on-resistance and maximum DC current capability
- ♦ SOT-23 package design

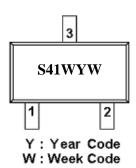
APPLICATIONS

- Power Management in Note book
- Portable Equipment
- Battery Powered System
- DC/DC Converter
- Load Switch
- DSC
- LCD Display inverter

PIN CONFIGURATION(SOT-23)



PART MARKING



PIN DESCRIPTION

Pin	Symbol	Description
1	G	Gate
2	S	Source
3	D	Drain

ORDERING INFORMATION

Part Number	Package	Part Marking
SPP3401WS23RG	SOT-23	S41W

Week Code : A ~ Z(1 ~ 26); a ~ z(27 ~ 52)

% SPP3401WS23RG : Tape Reel ; Pb - Free

ABSOULTE MAXIMUM RATINGS

(Ta=25°C Unless otherwise noted)

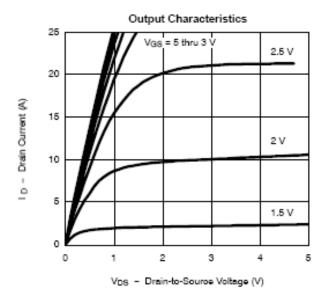
Parameter	Symbol	Typical	Unit		
Drain-Source Voltage		Vdss	-30	V	
Gate –Source Voltage		VGSS	±12	V	
Continuous Drain Current(T _J =150°C)	Ta=25°C	ID	-4.0	A	
Continuous Diani Current (13–130 C)	Ta=70°C	ID	-3.2	A	
Pulsed Drain Current	Ірм	-15	A		
Continuous Source Current(Diode Conduction)		Is	-1.0	A	
Power Dissination	Ta=25°C	PD	1.25	W	
Power Dissipation	Ta=70°C	PD	0.8	VV	
Operating Junction Temperature		TJ	150	$^{\circ}\mathbb{C}$	
Storage Temperature Range		Tstg	-55/150	$^{\circ}\!\mathbb{C}$	
Thermal Resistance-Junction to Ambient		RθJA	120	°C/W	

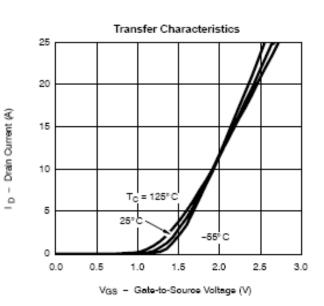
ELECTRICAL CHARACTERISTICS

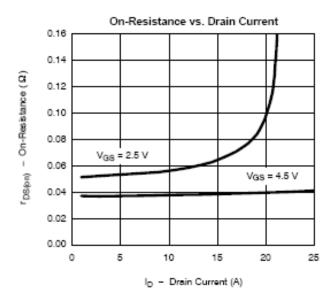
(Ta=25°C Unless otherwise noted)

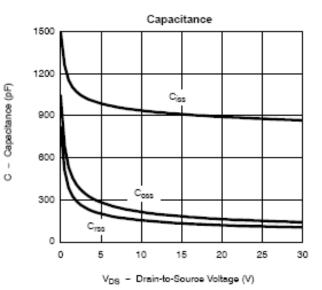
Parameter	Symbol	Conditions	Min.	Тур	Max.	Unit	
Static	•						
Drain-Source Breakdown Voltage	V(BR)DSS	V _G s=0V,I _D =-250uA	-30			V	
Gate Threshold Voltage	VGS(th)	VDS=VGS,ID=-250uA	-0.4		-1.0	V	
Gate Leakage Current	Igss	V _{DS} =0V,V _{GS} =±12V			±100	nA	
		V _{DS} =-24V,V _{GS} =0V			-1		
Zero Gate Voltage Drain Current	Idss	V _{DS} =-24V,V _{GS} =0V T _J =55°C			-10	uA	
On-State Drain Current	ID(on)	V _{DS} ≤-5V,V _{GS} =-10V	-10			A	
		V _{GS} =- 10V,I _D =-4.0A		0.068	0.077	Ω	
Drain-Source On-Resistance	RDS(on)	V _{GS} =-4.5V,I _D =-3.2A		0.088	0.099		
Forward Transconductance	~fa	V _{GS} =-2.5V,I _D =-1.2A V _{DS} =-5.0V,I _D =-4.0A		0.118	0.127	S	
	gfs	,			-1.2	V	
Diode Forward Voltage	Vsd	Is=-1.0A,VGS=0V		-0.8	-1.2	V	
Dynamic							
Total Gate Charge	Qg			10	18	nC	
Gate-Source Charge	Qgs	V _{DS} =-15V,V _{GS} =-10V I _D =-4.0A		1.6			
Gate-Drain Charge	Qgd	1D= 4.071		3.0		1	
Input Capacitance	Ciss			450		pF	
Output Capacitance	Coss	V _{DS} =-15V,V _{GS} =0V f=1MHz		95			
Reverse Transfer Capacitance	Crss	1-11/1112		55		1	
-	td(on)			8	18	- ns	
Turn-On Time	tr	$V_{DD}=-15V,R_L=15\Omega$		8	18		
	td(off)	ID=-1.0A,VGEN=-10V RG=6 Ω		25	50		
Turn-Off Time	tf	NG-022		25	35		

TYPICAL CHARACTERISTICS

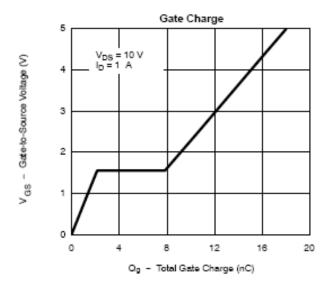


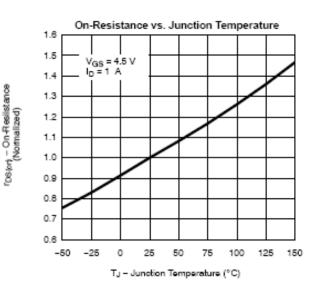


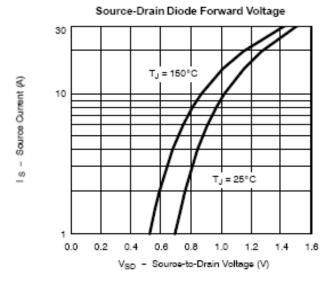


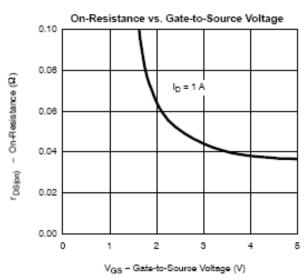


TYPICAL CHARACTERISTICS



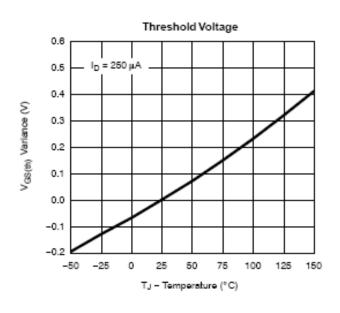


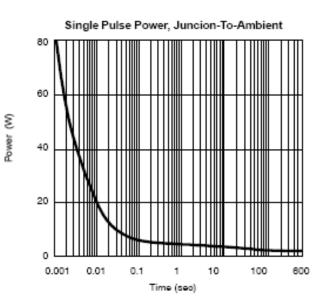


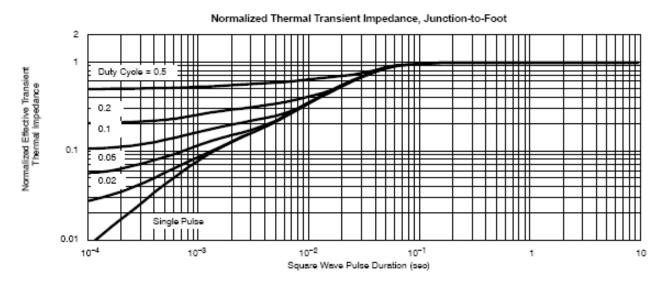




TYPICAL CHARACTERISTICS

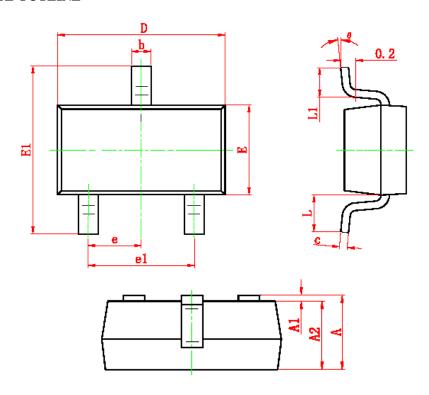








SOT-23 PACKAGE OUTLINE



Symbol	Dimensions In Millimeters		Dimensions In Inches		
	Min	Max	Min	Max	
Α	0.900	1.200	0.035	0.043	
A1	0.000	0.100	0.000	0.004	
A2	0.900	1.100	0.035	0.039	
b	0.300	0.500	0.012	0.020	
С	0.080	0.150	0.003	0.006	
D	2.800	3.000	0.110	0.118	
Е	1.200	1.400	0.047	0.055	
E1	2.250	2.550	0.089	0.100	
е	0.950 TYP		0.037 TYP		
e1	1.800	2.000	0.071	0.079	
L	0.550 REF		0.022 REF		
L1	0.300	0.500	0.012	0.020	
θ	0°	8°	0°	6°	



Information provided is alleged to be exact and consistent. SYNC Power Corporation presumes no responsibility for the penalties of use of such information or for any violation of patents or other rights of third parties which may result from its use. No license is granted by allegation or otherwise under any patent or patent rights of SYNC Power Corporation. Conditions mentioned in this publication are subject to change without notice. This publication surpasses and replaces all information previously supplied. SYNC Power Corporation products are not authorized for use as critical components in life support devices or systems without express written approval of SYNC Power Corporation.

©The SYNC Power logo is a registered trademark of SYNC Power Corporation
©2004 SYNC Power Corporation – Printed in Taiwan – All Rights Reserved
SYNC Power Corporation
7F-2, No.3-1, Park Street
NanKang District (NKSP), Taipei, Taiwan 115
Phone: 886-2-2655-8178
Fax: 886-2-2655-8468

©http://www.syncpower.com

